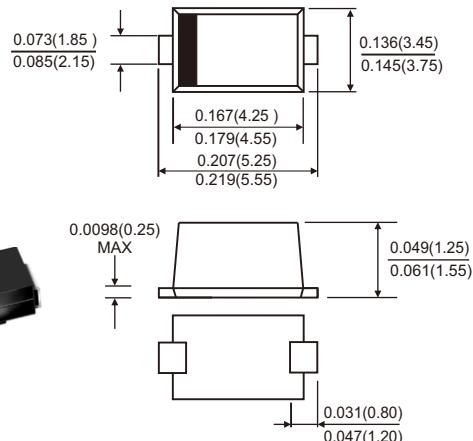


## FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2011/65/EU



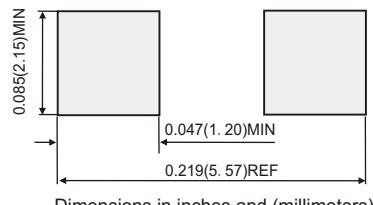
## SMBFL



## MECHANICAL DATA

- Case: SMBFL molded plastic body
- Terminals: Solder Plated, solderable per MIL-STD-750,method 2026
- Polarity: Color band denotes cathode end

## Suggested PAD Layout



Dimensions in inches and (millimeters)

## TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

## MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified )

Parameter	Symbol	SS56LBT	Unit
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	5.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I <sub>FSM</sub>	120	A
Operating junction temperature range	T <sub>J</sub>	-55 to+150	°C
Storage temperature range	T <sub>stg</sub>	-55 to+150	°C

## RATINGS AND CHARACTERISTIC OF SS56LBT

### ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instantaneous forward voltage	$I_F=5.0\text{A}$	$T_A=25^\circ\text{C}$	$V_F^{1)}$	0.46	0.52	V
		$T_A=100^\circ\text{C}$		0.45	-	
		$T_A=125^\circ\text{C}$		0.43	-	
Reverse current	$V_R=40\text{V}$	$T_A=25^\circ\text{C}$	$I_R^{2)}$	60	150	$\mu\text{A}$
		$T_A=100^\circ\text{C}$		5	-	mA
		$T_A=125^\circ\text{C}$		15	-	
Typical junction capacitance	$4\text{V}, 1\text{MHz}$		$C_J$	370		pF

Notes: 1.Pulse test: 300  $\mu\text{s}$  pulse width,1% duty cycle

2.Pulse test: pulse width  $\leqslant 40\text{ms}$

### THERMAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	SS56LBT	Unit
Typical thermal resistance	$R_{\theta JA}^{3)}$	90	$^\circ\text{C}/\text{W}$
	$R_{\theta JL}^{4)}$	30	

3.Free air,mounted on recommended PCB ,2 oz.pad area

4.The heat generated must be less than thermal conductivity from junction to ambient: $dPD/dtJ < 1/R_{\theta JA}$

# RATINGS AND CHARACTERISTIC OF SS56LBT

FIG.1-FORWARD CURRENT DERATING CURVE

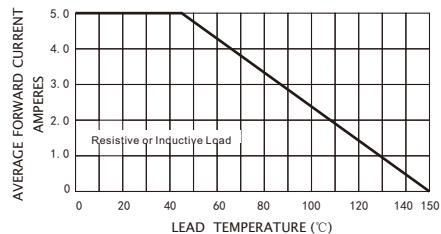


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

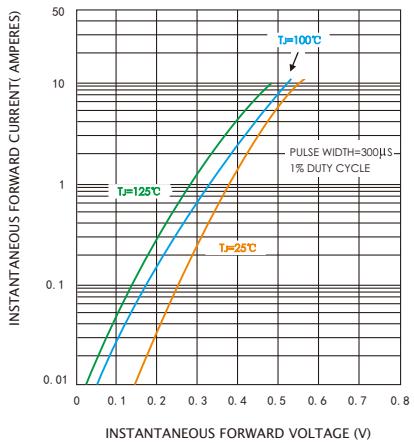


FIG.5-TYPICAL JUNCTION CAPACITANCE

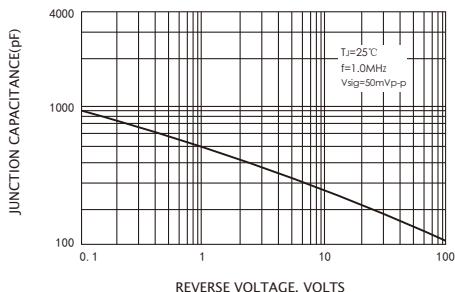


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

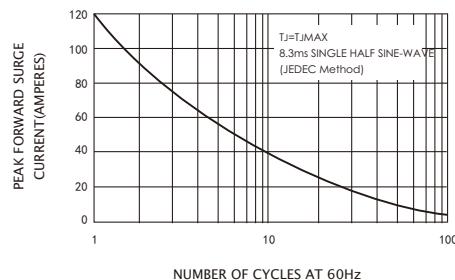


FIG.4-TYPICAL REVERSE CHARACTERISTICS

